TEXAS INSTRUMENTS

Data sheet acquired from Harris Semiconductor SCHS205C

CD54/74HC4049, CD54/74HC4050

High-Speed CMOS Logic

February 1998 - Revised March 2002

Features

- Typical Propagation Delay: 6ns at V_{CC} = 5V, C_L = 15pF, T_A = 25^oC
- High-to-Low Voltage Level Converter for up to V_I = 16V
- Fanout (Over Temperature Range)
 - Standard Outputs 10 LSTTL Loads
 - Bus Driver Outputs 15 LSTTL Loads
- Wide Operating Temperature Range ... –55°C to 125°C
- · Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
 - 2V to 6V Operation
 - High Noise Immunity: N_{IL} = 30%, N_{IH} = 30% of V_{CC} at V_{CC} = 5V

Description

The 'HC4049 and 'HC4050 are fabricated with high-speed silicon gate technology. They have a modified input protection structure that enables these parts to be used as logic level translators which convert high-level logic to a low-level logic while operating off the low-level logic supply. For example, 15-V input pulse levels can be down-converted to 0-V to 5-V logic levels. The modified input protection structure protects the input from negative electrostatic

discharge. These parts also can be used as simple buffers or inverters without level translation. The 'HC4049 and 'HC4050 are enhanced versions of equivalent CMOS types.

Hex Buffers, Inverting and Non-Inverting

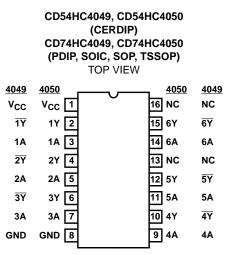
Ordering Information

PART NUMBER	TEMP. RANGE (^o C)	PACKAGE
CD54HC4049F3A	-55 to 125	16 Ld CERDIP
CD74HC4049E	-55 to 125	16 Ld PDIP
CD74HC4049M	-55 to 125	16 Ld SOIC
CD74HC4049NSR	-55 to 125	16 Ld SOP
CD54HC4050F3A	-55 to 125	16 Ld CERDIP
CD74HC4050E	-55 to 125	16 Ld PDIP
CD74HC4050M	-55 to 125	16 Ld SOIC
CD74HC4050NSR	-55 to 125	16 Ld SOP
CD74HC4050PW	-55 to 125	16 Ld TSSOP

NOTES:

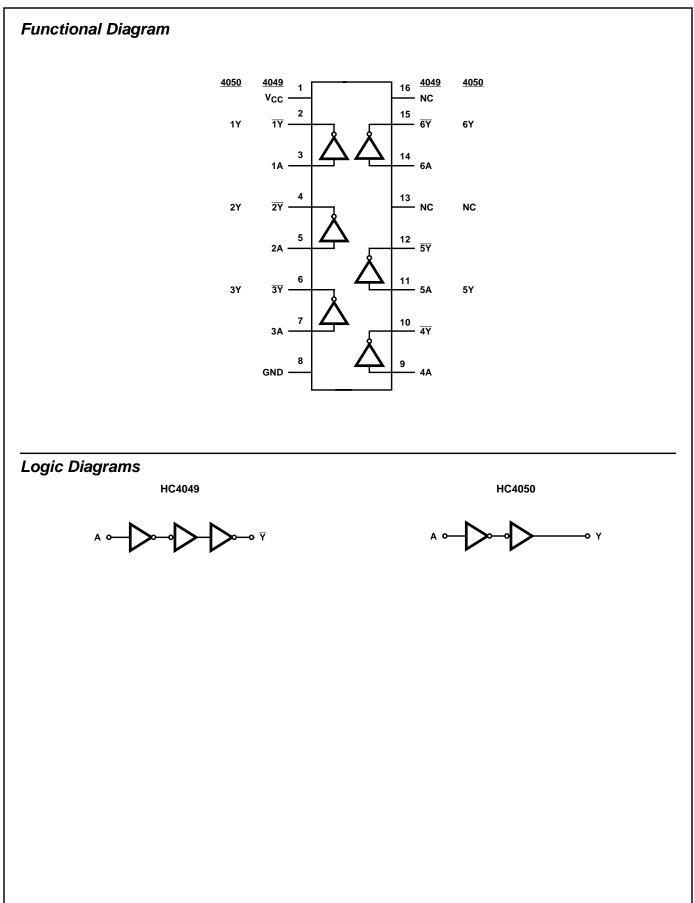
- When ordering, use the entire part number. Add the suffix 96 to the M suffix or the R suffix to the PW package to obtain the variant in the tape and reel.
- 2. Wafer and die is available which meets all electrical specifications. Please contact your local TI sales office or customer service for ordering information.

Pinout



CAUTION: These devices are sensitive to electrostatic discharge. Users should follow proper IC Handling Procedures.

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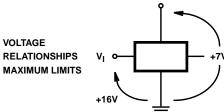


Absolute Maximum Ratings

DC Supply Voltage, V _{CC} 0.5V to 7V
DC Input Diode Current, IIK
For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$
DC Output Diode Current, I _{OK}
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V\pm 20$ mA
DC Output Source or Sink Current per Output Pin, IO
For $V_{O} > -0.5V$ or $V_{O} < V_{CC} + 0.5V\pm 25$ mA
DC V _{CC} or Ground Current, I _{CC or} I _{GND} ±50mA
Operating Conditions

Thermal Information

Package Thermal Impedance, θ_{JA} (see Note 3):
PDIP Package
SOIC Package
SOP Package 64°C/W
TSSOP Package 108°C/W
Maximum Junction Temperature (Hermetic Package or Die) 175°C
Maximum Junction Temperature (Plastic Package) 150°C
Maximum Storage Temperature Range65°C to 150°C
Maximum Lead Temperature (Soldering 10s)
(SOIC - Lead Tips Only)
V _{CC}



CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

3. The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

PARAMETER		TEST CONDITIONS		Vcc	25 ⁰ C			-40°C 1	го 85°С	–55 ⁰ C TO 125 ⁰ C		
	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
HC TYPES												-
High Level Input V _{IH} Voltage	VIH	-	-	2	1.5	-	-	1.5	-	1.5	-	V
				4.5	3.15	-	-	3.15	-	3.15	-	V
				6	4.2	-	-	4.2	-	4.2	-	V
Low Level Input	VIL	-	-	2	-	-	0.5	-	0.5	-	0.5	V
Voltage				4.5	-	-	1.35	-	1.35	-	1.35	V
				6	-	-	1.8	-	1.8	-	1.8	V
High Level Output Voltage CMOS Loads	VOH	V _{OH} V _{IH} or V _{IL}	-0.02	2	1.9	-	-	1.9	-	1.9	-	V
			-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V
			-0.02	6	5.9	-	-	5.9	-	5.9	-	V
High Level Output	7		-4	4.5	3.98	-	-	3.84	-	3.7	-	V
Voltage TTL Loads			-5.2	6	5.48	-	-	5.34	-	5.2	-	V
Low Level Output Voltage CMOS Loads	V _{OL}	V_{IH} or V_{IL}	0.02	2	-	-	0.1	-	0.1	-	0.1	V
			0.02	4.5	-	-	0.1	-	0.1	-	0.1	V
			0.02	6	-	-	0.1	-	0.1	-	0.1	V
Low Level Output			4	4.5	-	-	0.26	-	0.33	-	0.4	V
Voltage TTL Loads	ě l		5.2	6	-	-	0.26	-	0.33	-	0.4	V
Input Leakage Current	lı	V _{CC} or GND	-	6	-	-	±0.1	-	±1	-	±1	μA
		15	-	6	-	-	±0.5	-	±5	-	±5	
Quiescent Device Current	ICC	V _{CC} or GND	0	6	-	-	2	-	20	-	40	μA

Switching Specifications Input tr, tf = 6ns

	SYMBOL	TEST CONDITIONS		25 ⁰ C			–40 ⁰ С ТО 85 ⁰ С		–55 ⁰ C TO 125 ⁰ C		
PARAMETER			V _{CC} (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
HC TYPES										_	-
Propagation Delay, nA to nY HC4049 nA to nY HC4050	t _{PLH} , t _{PHL}	$C_L = 50 pF$	2	-	-	85	-	105	-	130	ns
			4.5	-	-	17	-	21	-	26	ns
			6	-	-	14	-	18	-	22	ns
		C _L = 15pF	5	-	6	-	-	-	-	-	ns
Transition Times (Figure 1)	t _{TLH} , t _{THL}	$C_L = 50 pF$	2	-	-	75	-	95	-	110	ns
			4.5	-	-	15	-	19	-	22	ns
			6	-	-	13	-	16	-	19	ns
Input Capacitance	C _I	-	-	-	-	10	-	10	-	10	pF
Power Dissipation Capacitance (Notes 4, 5)	C _{PD}	-	5	-	35	-	-	-	-	-	pF

NOTES:

4. C_{PD} is used to determine the dynamic power consumption, per gate.

5. $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ where f_i = Input Frequency, C_L = Output Load Capacitance, V_{CC} = Supply Voltage.

Test Circuit and Waveform

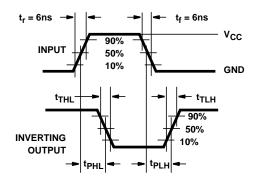


FIGURE 1. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

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